

Notice of References Cited

Application/Control No.

09/853,806

Applicant(s)/Patent Under

Reexamination

BLUMENDFELD ET AL.,

Examiner

Frank W Lu

Art Unit

1634

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U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-6,428,749	08-2002	Kajiyama et al.,	422/68.1
	B	US-			
	C	US-			
	D	US-			
	E	US-			
	F	US-			
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	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

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	N					
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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Peterson et al., Experimental investigation of micro heat pipes fabricated in silicon wafers. Journal of Heat Transfer, 115, 751-756, 1993.
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
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